Low frequency transistor (–20V, –5A) 2SB1386 / 2SB1412 / 2SB1326

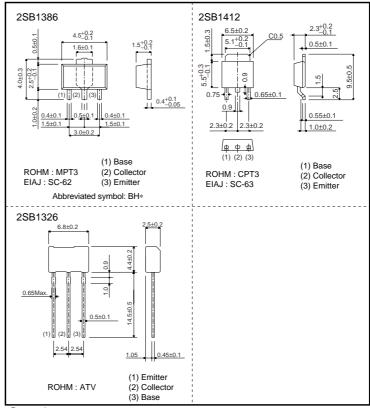
Features

- 1) Low VCE(sat). VCE(sat) = -0.35V (Typ.)(Ic/IB = -4A / -0.1A)
- 2) Excellent DC current gain characteristics.
- 3) Complements the 2SD2098 / 2SD2118 / 2SD2097.

Structure

Epitaxial planar type PNP silicon transistor

●External dimensions (Units: mm)



● Absolute maximum ratings (Ta=25°C)

Parameter		Symbol	Limits	Unit	
Collector-base voltage		Vсво	-30	V	
Collector-emitter voltage		VCEO	-20	V	
Emitter-base voltage		VEBO	-6	V	
Collector current		1-	-5	A(DC)	
		lc	-10	A(Pulse) *1	
Collector power dissipation	2SB1386		0.5	W	
			2	W *2	
	2SB1412	Pc	1	W	
			10	W(Tc=25°C)	
	2SB1326		1	W *3	
Junction temperature		Tj	150	°C	
Storage temperature		Tstg	-55~+150	°C	

●Electrical characteristics (Ta=25°C)

Parameter		Symbol	Min.	Тур.	Max.	Unit	Conditions	
Collector-base breakdown voltage		ВУсво	-30	_	-	V	Ic=-50μA	
Collector-emitter breakdown voltage		BVceo	-20	_	_	V	Ic=-1mA	
Emitter-base breakdown voltage		ВУево	-6	_	_	V	Iε=-50μA	
Collector cutoff current		Ісво	-	_	-0.5	μΑ	Vcb=-20V	
Emitter cutoff current		ІЕВО	-	-	-0.5	μА	V _{EB} =-5V	
Collector-emitter saturation voltage		VCE(sat)	-	_	-1.0	V	Ic/I _B =-4A/-0.1A	*
DC current	2SB1386,2SB1412		82	-	390	-	Vce=-2V, Ic=-0.5A	*
transfer ratio	2SB1326	hfe	120	_	390	-		*
Transition frequency		f⊤	-	120	-	MHz	Vce=-6V, Ie=50mA, f=30MHz	
Output capacitance		Cob	-	60	_	pF	Vcb=-20V, IE=0A, f=1MHz	

^{*}Measured using pulse current.

●Packaging specifications and hFE

		Package	Taping				
		Code	T100	TL	TV2		
Туре	hfe	Basic ordering unit (pieces)	1000	2500	2500		
2SB1386	PQR		0	-	_		
2SB1412	PQR		PQR		-	0	-
2SB1326	QR		_	-	0		

hre values are classified as follows:

Item	Р	Q	R	
hfE	82~180	120~270	180~390	

^{*1} Single pulse, Pw=10ms
*2 When mounted on a 40×40×0.7 mm ceramic board.
*3 Printed circuit board glass epoxy board 1.6 mm thick with copper plating 100mm² or larger.

Electrical characteristic curves

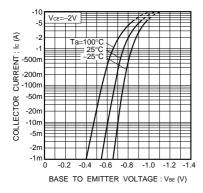


Fig.1 Grounded emitter propagation characteristics

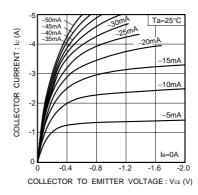


Fig.2 Grounded emitter output characteristics

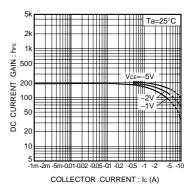


Fig.3 DC current gain vs. collector current (I)

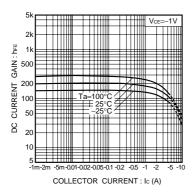


Fig.4 DC current gain vs. collector current (II)

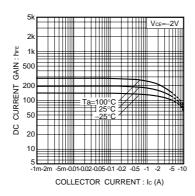


Fig.5 DC current gain vs. collector current (III)

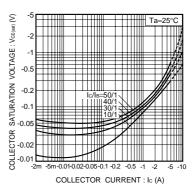


Fig.6 Collector-emitter saturation voltage vs. collector current (I)

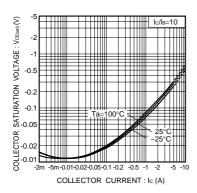


Fig.7 Collector-emitter saturation voltage vs. collector current (II)

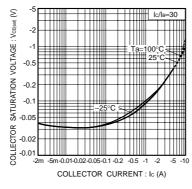


Fig.8 Collector-emitter saturation voltage vs. collector current (III)

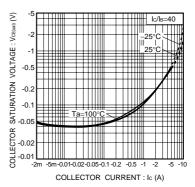


Fig.9 Collector-emitter saturation voltage vs. collector current (IV)

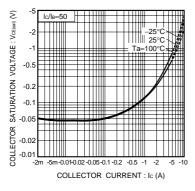


Fig.10 Collector-emitter saturation voltage vs. collector current (V)

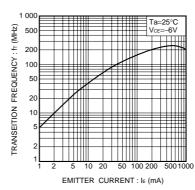


Fig.11 Gain bandwidth product vs. emitter current

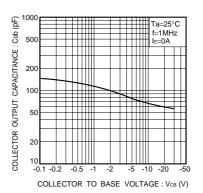


Fig.12 Collector output capacitance vs. collector-base voltage

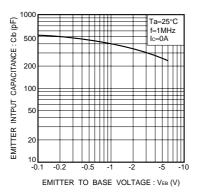
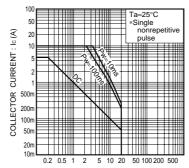


Fig.13 Emitter input capacitance vs. emitter-base voltage



COLLECTOR TO EMITTER VOLTAGE: -VcE (V)

Fig.14 Safe operation area (2SB1412)